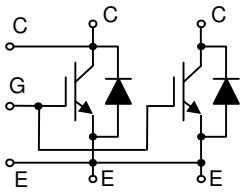
MBN800E33E

Silicon N-channel IGBT 3300V E version

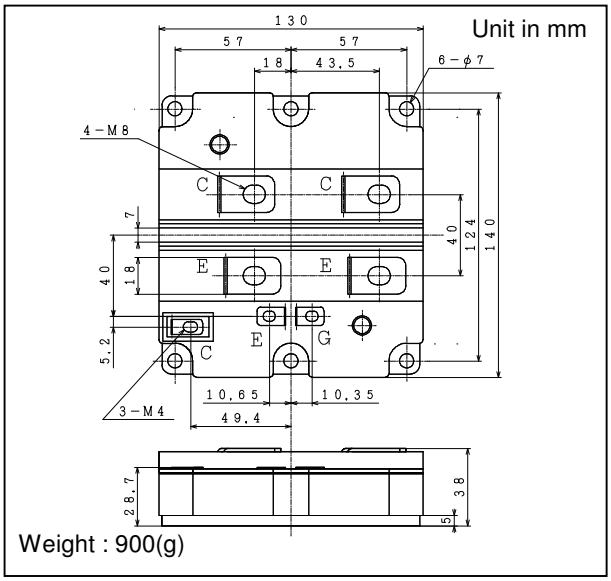
FEATURES

- Soft switching behavior & low conduction loss:
  Soft low-injection punch-through
  High conductivity IGBT.
- Low driving power due to low input
  capacitance MOS gate.
- Low noise recovery: Ultra soft fast recovery diode.
- High thermal fatigue durability:
  (delta Tc=70K, N>30,000cycles)
  AlSiC base-plate/AlN substrate

CIRCUIT DIAGRAM



OUTLINE DRAWING



Weight : 900(g)

ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

Item		Symbol	Unit	MBN800E33E
Collector Emitter Voltage		V_{CES}	V	3,300
Gate Emitter Voltage		V_{GES}	V	±20
Collector Current	DC	I_C	A	800
	1ms	I_{Cp}		1,600
Forward Current	DC	I_F	A	800
	1ms	I_{FM}		1,600
Junction Temperature		T_j	°C	-40 ~ +125
Storage Temperature		T_{stg}	°C	-40 ~ +125
Isolation Voltage		V_{ISO}	V_{RMS}	6,000(AC 1 minute)
Screw Torque	Terminals (M4/M8)	-	N·m	2/15 (1)
	Mounting (M6)	-		6 (2)

Notes: (1) Recommended Value 1.8±0.2/15^{+0}_{-3}N·m (2) Recommended Value 5.5±0.5N·m

ELECTRICAL CHARACTERISTICS

Item		Symbol	Unit	Min.	Typ.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I_{CES}	mA	-	-	12.0	V_{CE}=3,300V, V_{GE}=0V, Tj=25°C
				-	14	40	V_{CE}=3,300V, V_{GE}=0V, Tj=125°C
Gate Emitter Leakage Current		I_{GES}	nA	-500	-	+500	V_{GE}=±20V, V_{CE}=0V, Tj=25°C
Collector Emitter Saturation Voltage		$V_{CE(sat)}$	V	3.0	3.5	4.2	I_C=800A, V_{GE}=15V, Tj=125°C
Gate Emitter Threshold Voltage		$V_{GE(TO)}$	V	4.5	6.0	7.0	V_{CE}=10V, I_C=800mA, Tj=25°C
Input Capacitance		C_{ies}	nF	-	70	-	V_{CE}=10V, V_{GE}=0V, f=100kHz, Tj=25°C
Internal Gate Resistance		Rg(int)	Ω	-	2.0	-	V_{CE}=10V, V_{GE}=0V, f=100kHz, Tj=25°C
Switching Times	Rise Time	t_r	µs	1.1	2.1	3.1	V_{CC}=1,650V, Ic=800A
	Turn On Time	t_{on}		1.7	2.5	3.3	L=120nH
	Fall Time	t_f		1.3	2.2	3.1	R_G=6.8Ω (3)
	Turn Off Time	t_{off}		2.7	4.2	5.7	V_{GE}=±15V, Tj=125°C
Peak Forward Voltage Drop		V_{FM}	V	2.0	2.5	3.0	Ic=800A, V_{GE}=0V, Tj=125°C
Reverse Recovery Time		t_{rr}	µs	0.2	0.7	1.2	V_{CC}=1,650V, Ic=800A, L=120nH Tj=125°C
Turn On Loss		$E_{on(10\%)}$	J/P	-	1.4	1.8	V_{CC}=1,650V, Ic=800A, L=120nH
Turn Off Loss		$E_{off(10\%)}$	J/P	-	1.4	1.9	R_G=6.8Ω (3)
Reverse Recovery Loss		$E_{rr(10\%)}$	J/P	-	1.0	1.5	V_{GE}=±15V, Tj=125°C
Stray inductance module		L_{SCE}	nH	-	18	-	
Thermal Impedance	IGBT	Rth(j-c)	°C/W	-	-	0.013	Junction to case
	FWD	Rth(j-c)		-	-	0.026	
Contact Thermal Impedance		Rth(c-f)	°C/W	-	0.008	-	Case to fin

Notes:(3) R_G value is a test condition value for evaluation, not recommended value.
Please, determine the suitable R_G value by measuring switching behaviors.

* Please contact our representatives at order.
* For improvement, specifications are subject to change without notice.
* For actual application, please confirm this spec sheet is the newest revision.

HITACHI
Inspire the Next

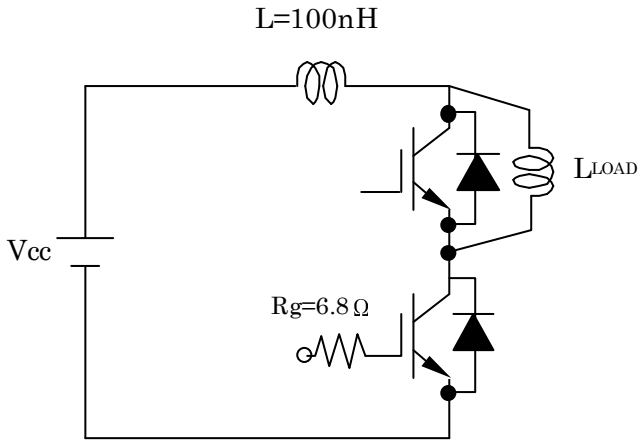
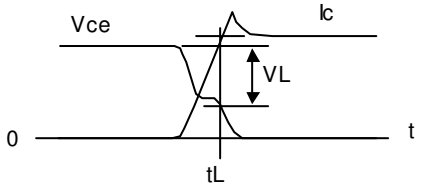
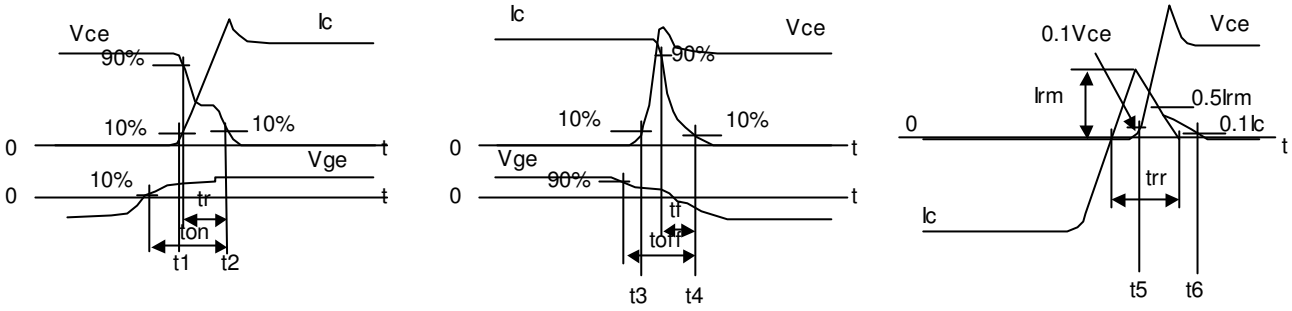


Fig. Switching Test circuit



$$L = \frac{V_L}{\left(\frac{dIc}{dt}\right)_{t=tL}}$$

Fig. Difinition of stray inductance

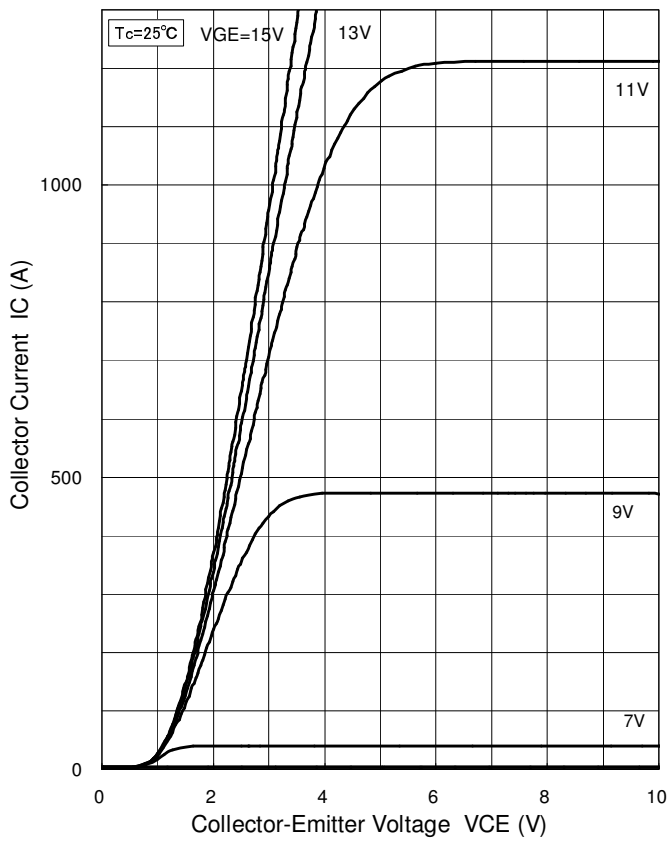


$$Eon(10\%) = \int_{t1}^{t2} Ic \cdot Vce\ dt \qquad Eoff(10\%) = \int_{t3}^{t4} Ic \cdot Vce\ dt \qquad Err(10\%) = \int_{t5}^{t6} IF \cdot Vce\ dt$$

$$Eon(Full) = \int_{t7}^{t8} Ic \cdot Vce\ dt \qquad Eoff(Full) = \int_{t9}^{t10} Ic \cdot Vce\ dt \qquad Err(Full) = \int_{t11}^{t12} IF \cdot Vce\ dt$$

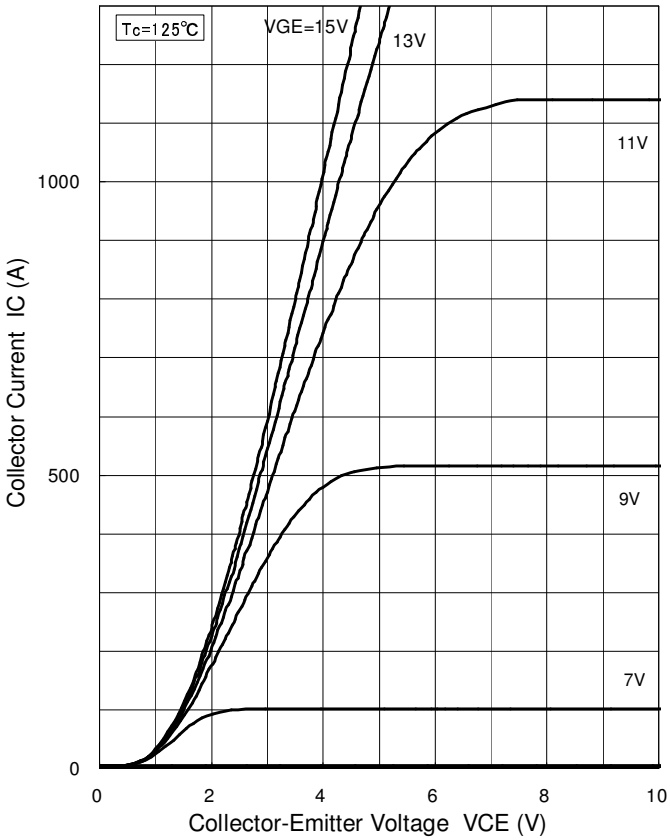
Fig. Definition of switching loss

TYPICAL



Collector Current vs. Collector to Emitter Voltage

TYPICAL



Collector Current vs. Collector to Emitter Voltage

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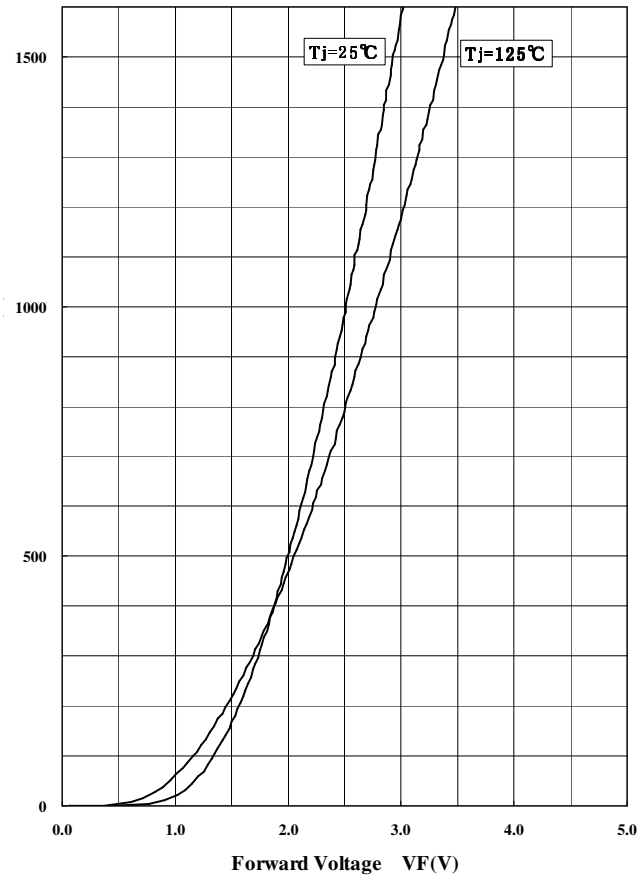
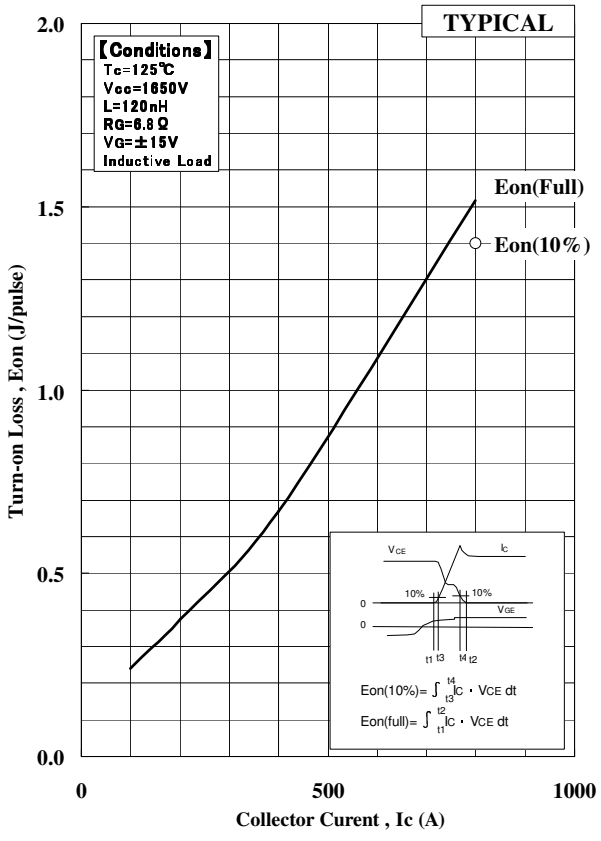
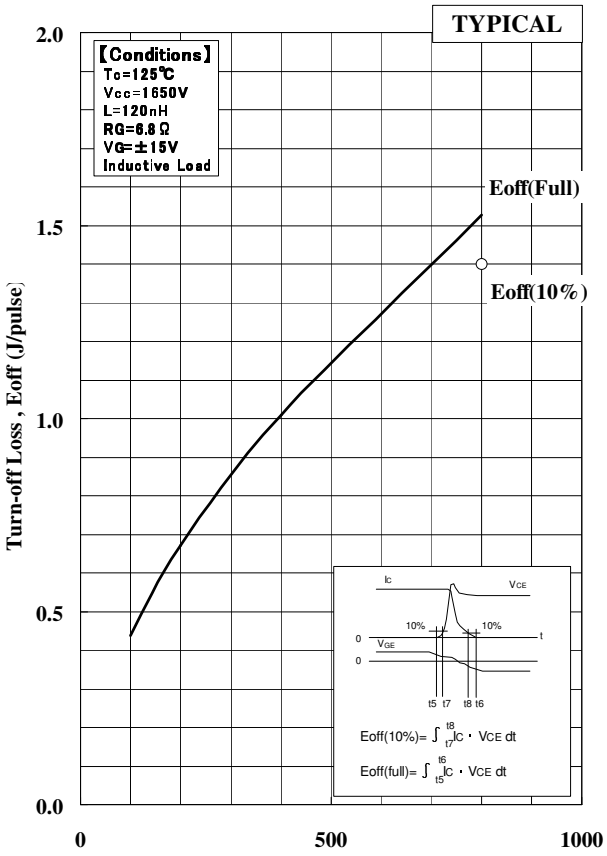


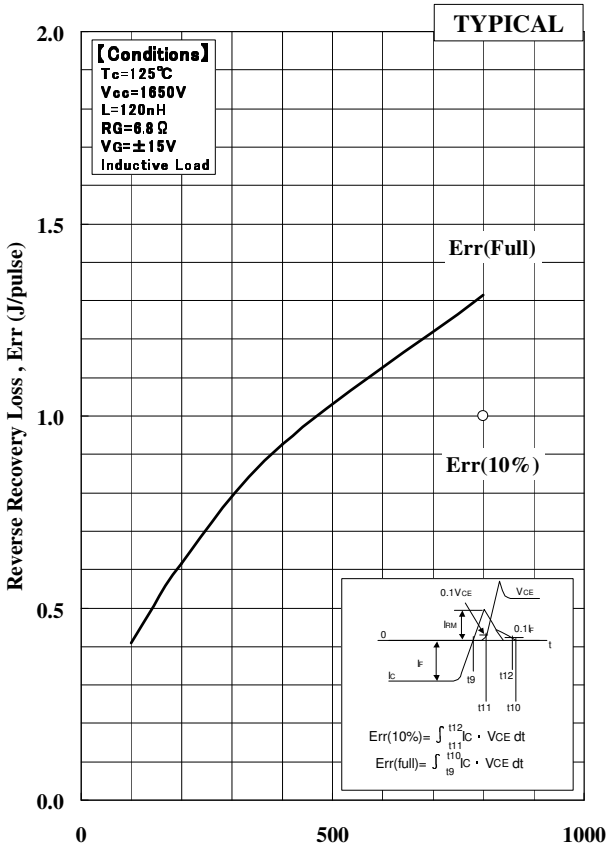
Forward Voltage of free-wheeling diode



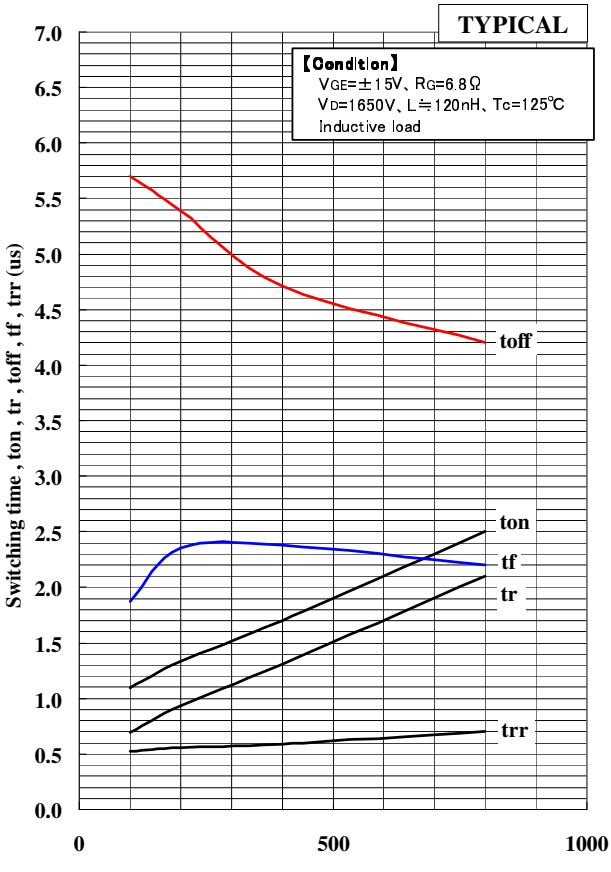
Turn-on Loss vs.Collector Current



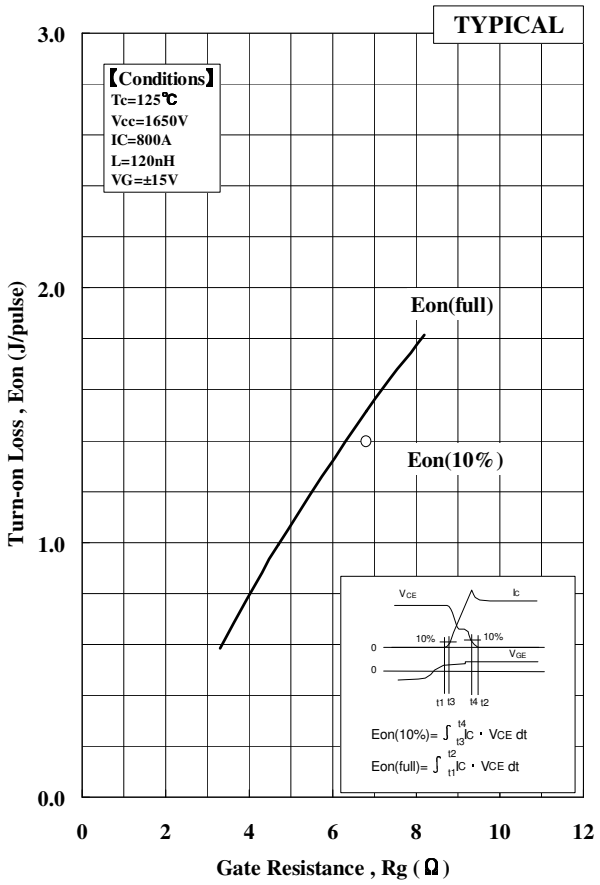
Turn-off Loss vs.Collector Current



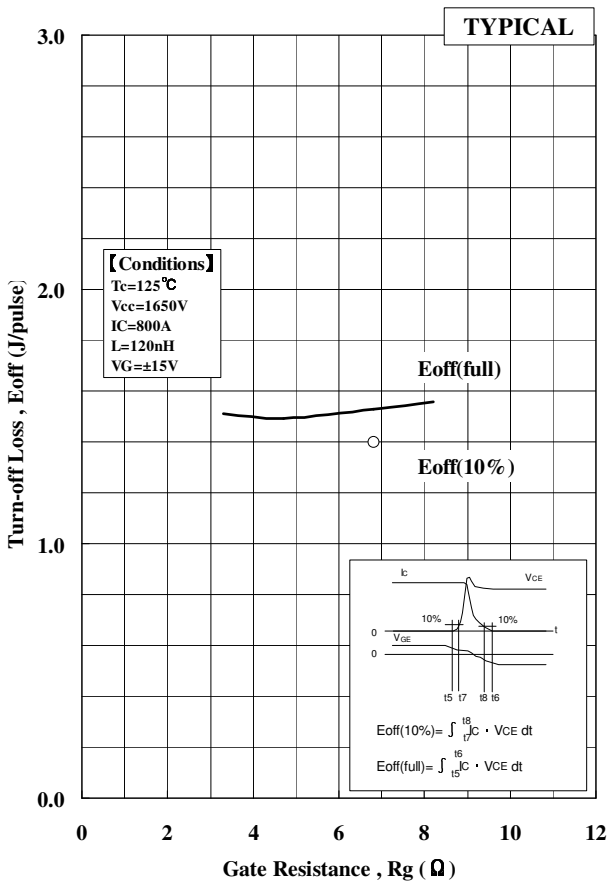
Recovery Loss vs.Collector Current



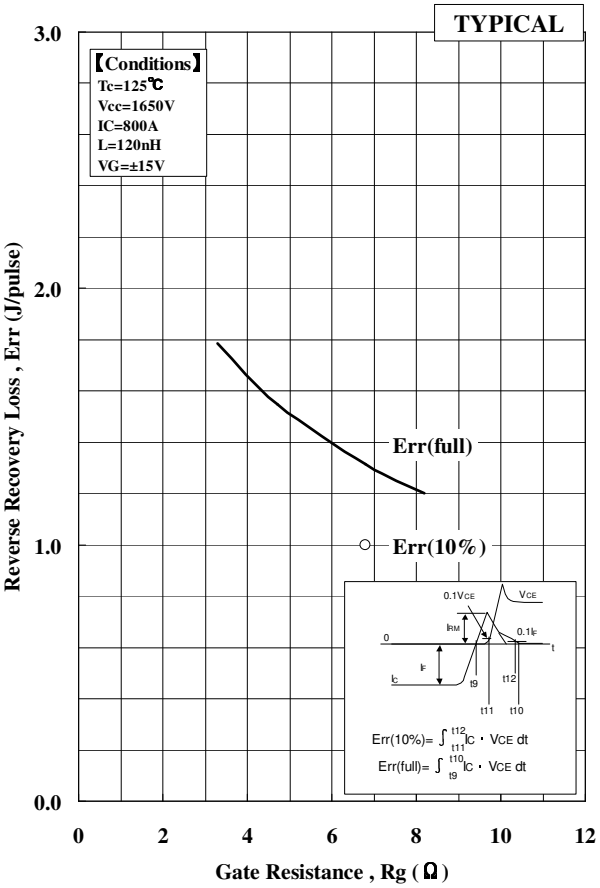
Switching time vs. Collector current



Turn-on Loss vs. Gate Resistance



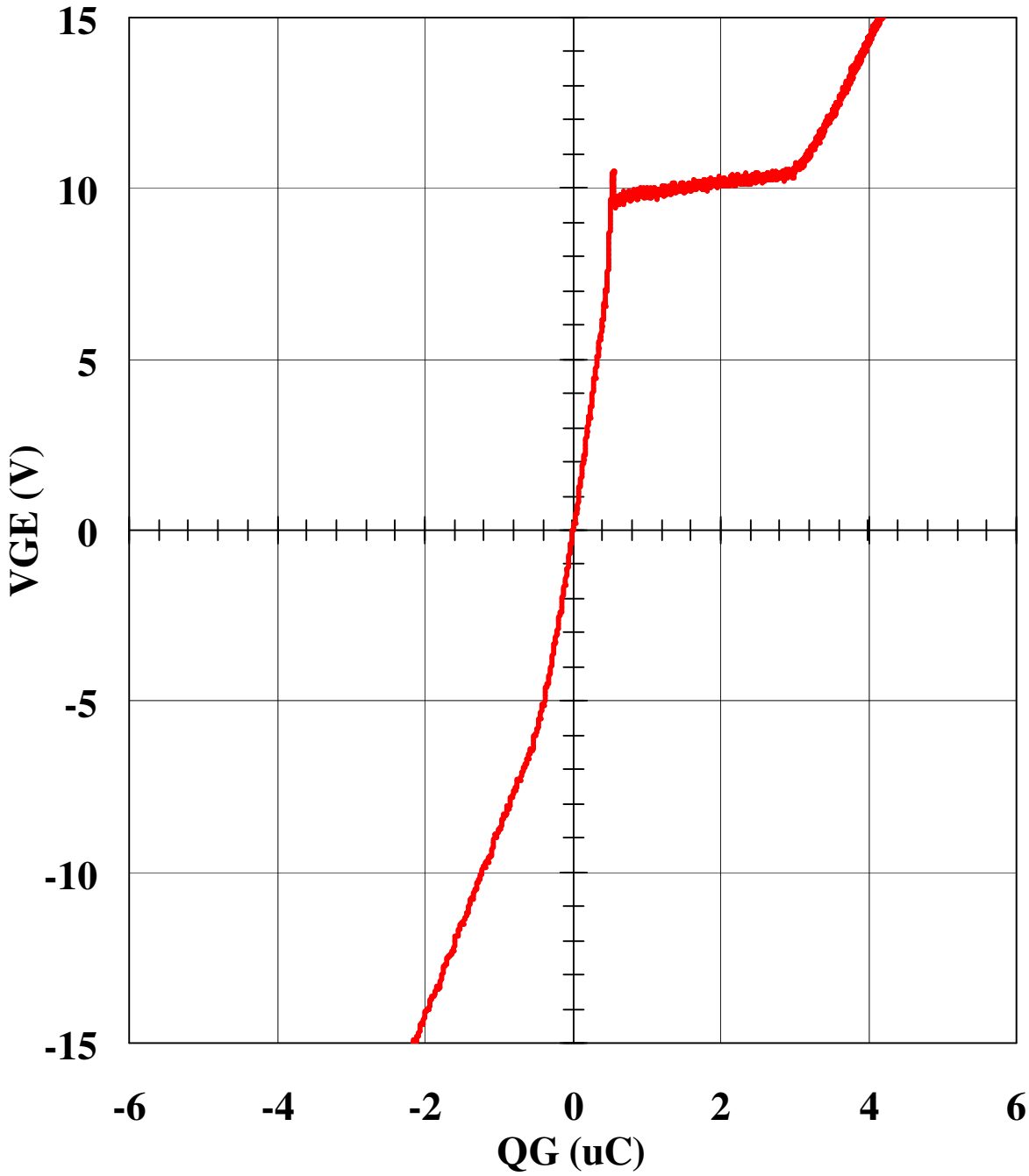
Turn-off Loss vs. Gate Resistance



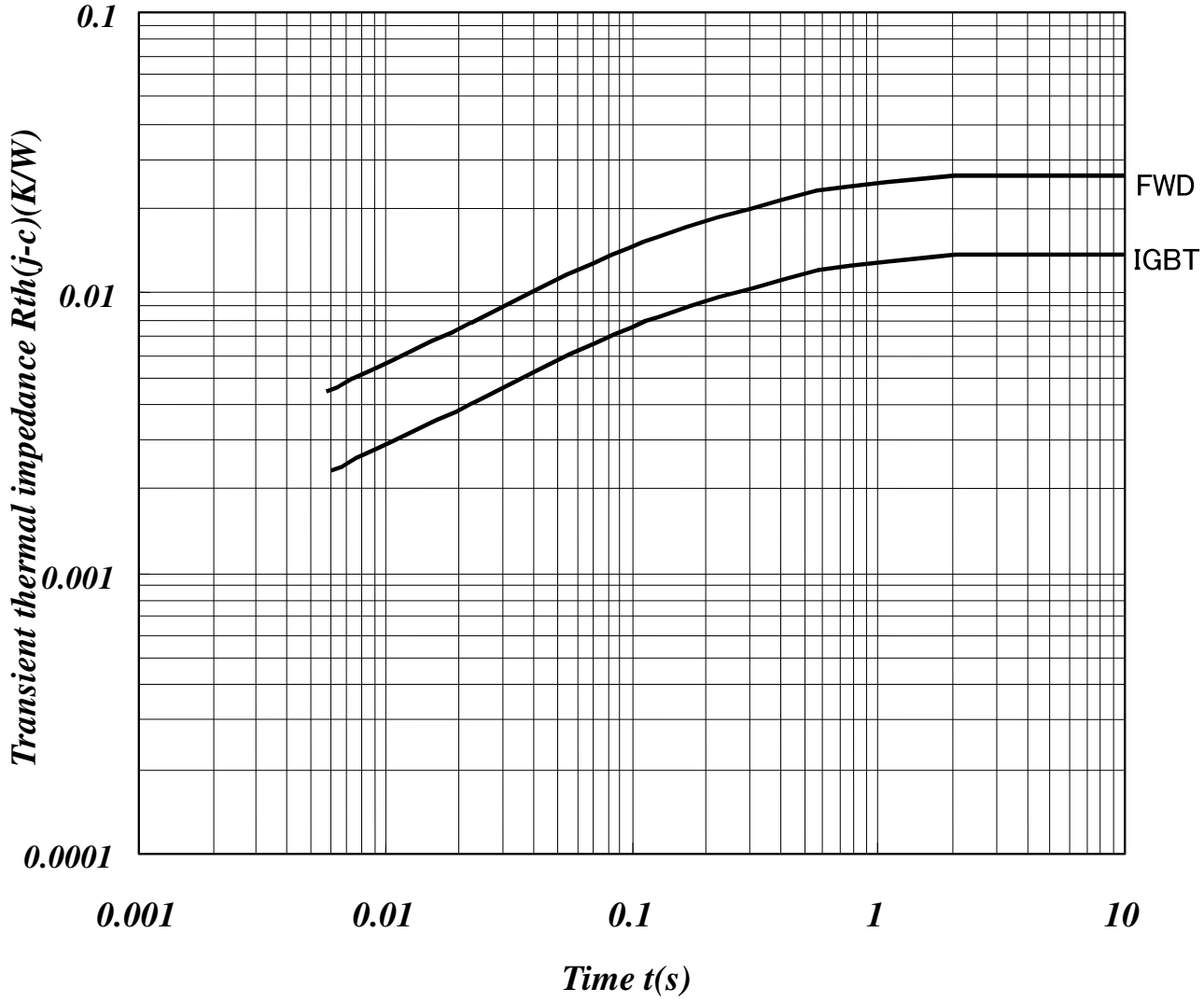
Recovery Loss vs. Gate Resistance

TYPICAL

Conditions:Ls=120nH,VCC=1650V,VGE=+/-15V,
RG(on/off)=68Ω/68Ω,Tj=25C,



QG-VGE curve



Transient Thermal Impedance Curve ***(Maximum Value)***

HITACHI POWER SEMICONDUCTORS

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